

	Type	Hits	Search Text	DBs	Time Stamp
1	BRS	1	((coefficient adj Thermal adj expansion) with (epoxy and (acrylic adj resin))	USPAT	2005/03/23 09:15
2	BRS	1	((coefficient adj Thermal adj expansion) with epoxy) and ((coefficient adj Thermal adj expansion) with (acrylic adj resin))	USPAT	2005/03/23 09:16
3	BRS	646	((coefficient adj Thermal adj expansion) with epoxy) or ((coefficient adj Thermal adj expansion) with (acrylic adj resin))	USPAT	2005/03/23 09:16
4	BRS	6	((coefficient adj Thermal adj expansion) with epoxy) same ((coefficient adj Thermal adj expansion) with (acrylic))	USPAT	2005/03/23 09:26
5	BRS	46	((coefficient adj Thermal adj expansion) with (acrylic))	USPAT	2005/03/23 11:01
6	BRS	11	((coefficient adj Thermal adj expansion) with (acrylic near3 resin))	USPAT	2005/03/23 09:27
7	BRS	130	360/264.2.CCLS.	USPAT	2005/03/23 11:01

	Type	L #	Hits	Search Text	Dbs	Time Stamp
1	BRS	L1	4232	flex adj circuit	US-PGPUB; USPAT	2005/03/22 12:40
2	BRS	L2	148	1 and (underfill\$4)	US-PGPUB; USPAT	2005/03/22 12:40
3	BRS	L3	35	1 and (underfill\$4 and (glob adj top))	US-PGPUB; USPAT	2005/03/22 12:46
4	BRS	L13	0	3 and capillary	US-PGPUB; USPAT	2005/03/22 12:43
5	BRS	L14	51	("no-flow" or (no adj flow) or (capillary adj flow)) same encapsulant	US-PGPUB; USPAT	2005/03/22 12:48